SunLED
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Part Number: ZM2BB81W-1

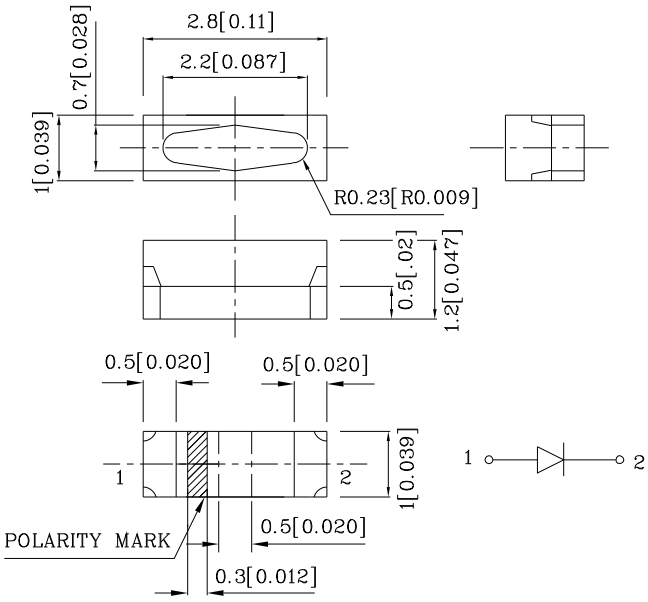
2.8X1.0mm RIGHT ANGLE SMD CHIP LED LAMP

PRELIMINARY SPEC

Features

- 2.8mmX1.0mm RIGHT ANGLE SMT LED, 1.2mm THICKNESS.
- LOW POWER CONSUMPTION.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE : 2000PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- RoHS COMPLIANT.

ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES



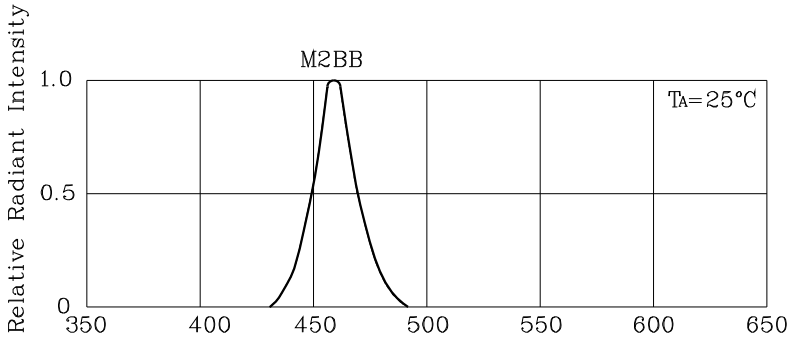
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25(0.01") unless otherwise noted.
3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T_A=25°C)		**M2BB (InGaN)**	**Unit**
Reverse Voltage	V_R	5	V
Forward Current	I_F	30	mA
Forward Current (peak) 1/10 Duty Cycle 0.1ms Pulse Width	iFS	100	mA
Power Dissipation	P_T	111	mW
Operating Temperature	T_A	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	
Electrostatic Discharge Threshold (HBM)		1000	V

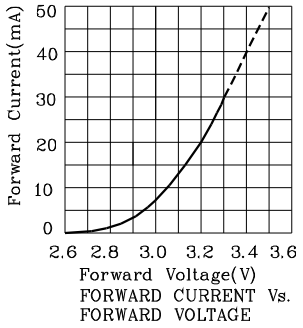
Operating Characteristics (T_A=25°C)		**M2BB (InGaN)**	**Unit**
Forward Voltage (Typ.) (I_F=20mA)	V_F	3.2	V
Forward Voltage (Max.) (I_F=20mA)	V_F	3.7	V
Reverse Current (Max.) (V_R=5V)	I_R	10	uA
Wavelength Of Peak Emission (Typ.) (I_F=20mA)	λ P	458	nm
Wavelength Of Dominant Emission (Typ.) (I_F=20mA)	λ D	465	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I_F=20mA)	Δλ	22	nm
Capacitance (Typ.) (V_F=0V, f=1MHz)	C	110	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
ZM2BB81W-1	Blue	InGaN	Water Clear	110	248	458	110°

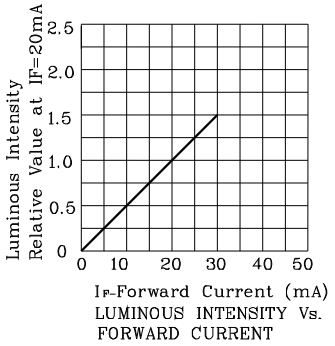


RELATIVE INTENSITY Vs. WAVELENGTH

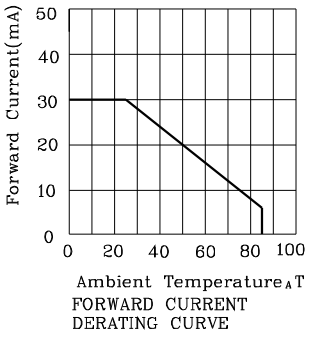
❖ **M2BB**



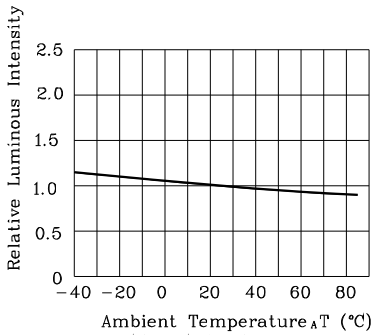
FORWARD CURRENT Vs.
FORWARD VOLTAGE



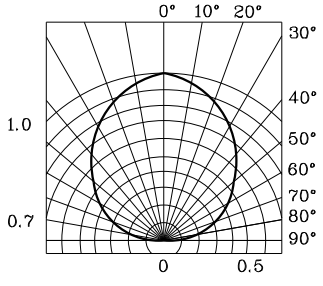
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

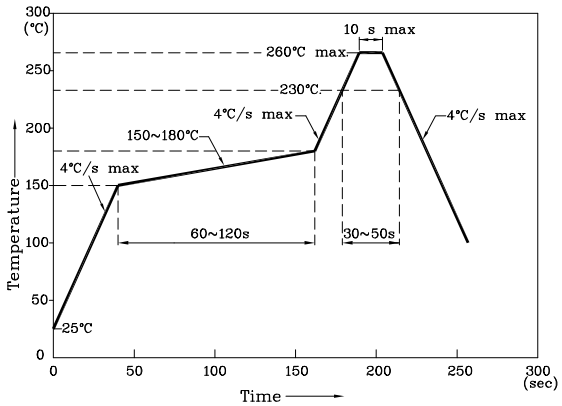


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

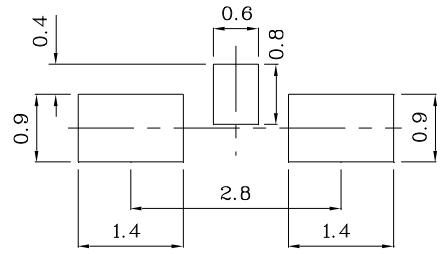
Reflow Soldering Profile For Lead-free SMT Process.



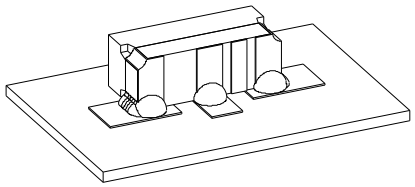
NOTES:

1. Maximum soldering temperature should not exceed 260°c.
2. Recommended reflow temperature: 145°c-260°c.
3. Do not put stress to the epoxy resin during high temperatures conditions.

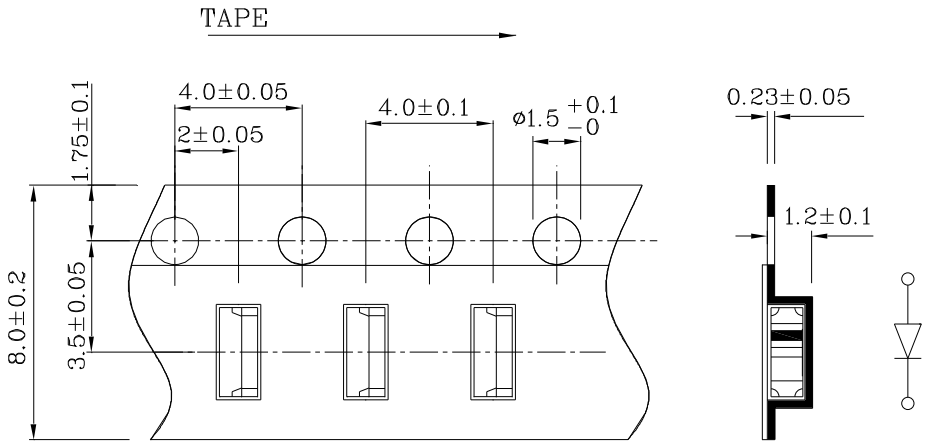
❖ Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



❖ The device has a single mounting surface. The device must be mounted according to the specifications.



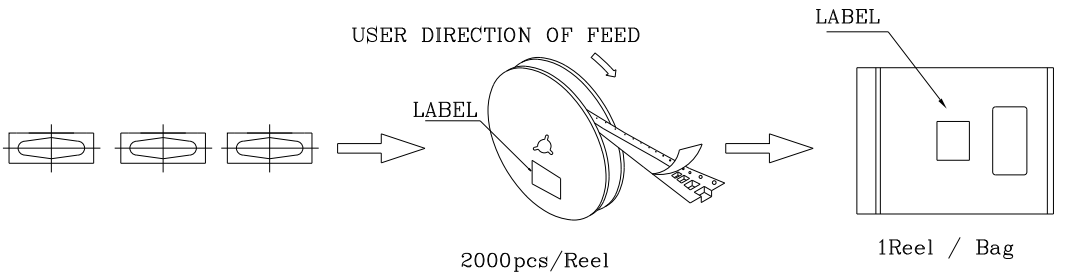
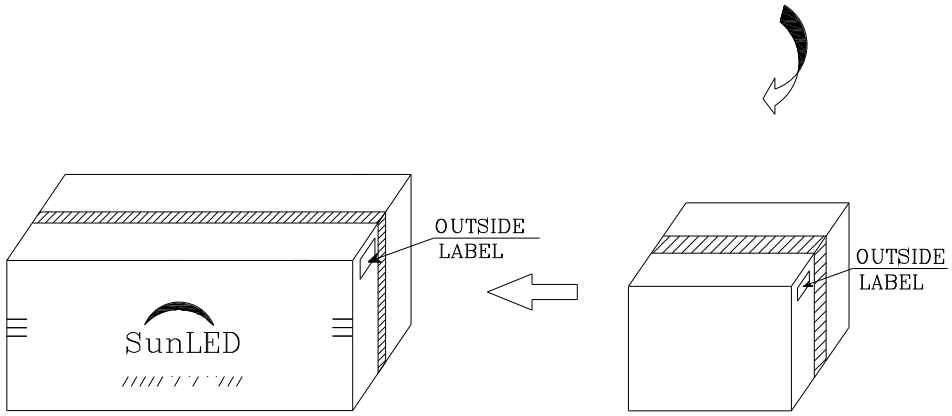
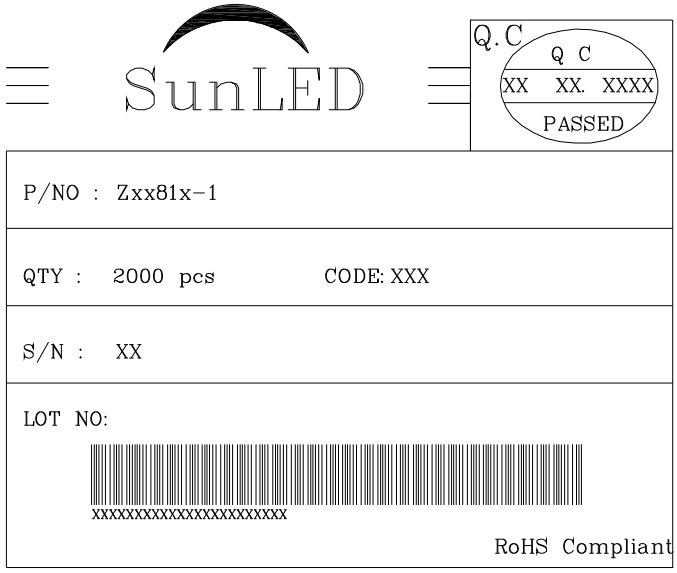
❖ Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous intensity / luminous flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS ZM2BB81W-1